



RADIATION HARDENED NPN SILICON SWITCHING TRANSISTOR

Qualified per MIL-PRF-19500/366

Qualified Levels:
JANSM, JANSJ,
JANSK, JANSL and
JANSR

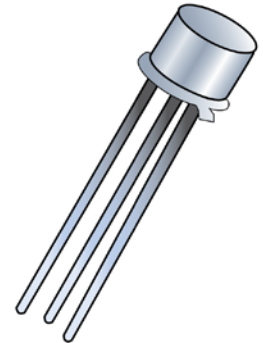
DESCRIPTION

This family of JANS 2N3498L through JANS 2N3501L epitaxial, planar transistors are military qualified in five RHA (Radiation Hardness Assurance) levels for high-reliability applications. These devices are also available in TO-39 and low profile surface mount UB packaging. Microsemi also offers numerous other radiation hardened transistor products to meet higher and lower power ratings with various switching speed requirements in both through-hole and surface-mount packages.

Important: For the latest information, visit our website <http://www.microsemi.com>.

FEATURES

- JEDEC registered 2N3498 through 2N3501 series numbers.
- RHA level JAN qualifications per MIL-PRF-19500/366 (see [part nomenclature](#) for all options).
- RoHS compliant by design.




TO-5 Package

APPLICATIONS / BENEFITS

- General purpose transistors for medium power applications requiring high frequency switching and radiation harness.
- Longer leaded TO-5 package.
- Lightweight.
- Military and other high-reliability applications.

Also available in:

 **TO-39 (TO-205AD)**
package
(leaded)
JANS 2N3498 – 2N3501

 **UB package**
(surface mount)
JANS 2N3501UB

MAXIMUM RATINGS @ T_C = +25 °C unless otherwise noted

Parameters / Test Conditions	Symbol	2N3498L 2N3499L	2N3500L 2N3501L	Unit
Collector-Emitter Voltage	V _{CEO}	100	150	V
Collector-Base Voltage	V _{CBO}	100	150	V
Emitter-Base Voltage	V _{EBO}	6.0	6.0	V
Collector Current	I _C	500	300	mA
Thermal Resistance Junction-to-Ambient	R _{θJA}	175		°C/W
Thermal Resistance Junction-to-Case	R _{θJC}	30		°C/W
Total Power Dissipation @ T _A = +25 °C ⁽¹⁾ @ T _C = +25 °C ⁽²⁾	P _T	1.0 5.0		W
Operating & Storage Junction Temperature Range	T _J , T _{stg}	-65 to +200		°C

- Notes:** 1. See [figure 1](#).
2. See [figure 2](#).

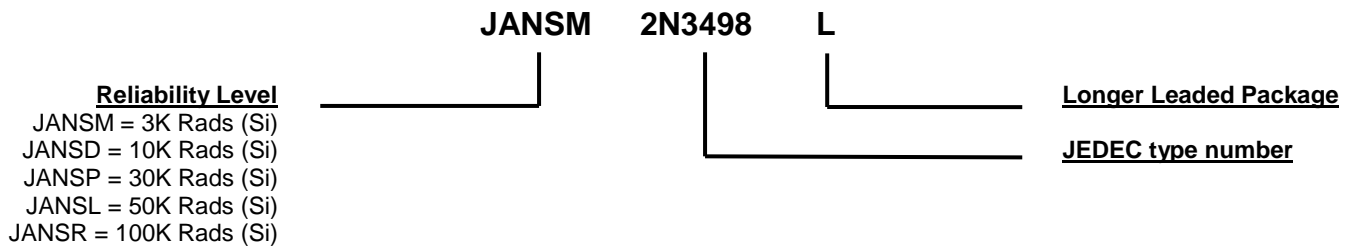
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MECHANICAL and PACKAGING

- CASE: Hermetically sealed, kovar base, nickel cap.
- TERMINALS: Leads are gold plated.
- MARKING: Part number, date code, manufacturer's ID.
- WEIGHT: Approximately 1.14 grams.
- See [Package Dimensions](#) on last page.

PART NOMENCLATURE

SYMBOLS & DEFINITIONS

Symbol	Definition
C_{obo}	Common-base open-circuit output capacitance
I_{CEO}	Collector cutoff current, base open
I_{CEX}	Collector cutoff current, circuit between base and emitter
I_{EBO}	Emitter cutoff current, collector open
h_{FE}	Common-emitter static forward current transfer ratio
V_{CEO}	Collector-emitter voltage, base open
V_{CBO}	Collector-emitter voltage, emitter open
V_{EBO}	Emitter-base voltage, collector open

ELECTRICAL CHARACTERISTICS @ $T_A = +25\text{ }^\circ\text{C}$, unless otherwise noted

Parameters / Test Conditions	Symbol	Min.	Max.	Unit
OFF CHARACTERISTICS				
Collector-Emitter Breakdown Voltage $I_C = 10\text{ mA}$, pulsed	2N3498L, 2N3499L 2N3500L, 2N3501L	$V_{(BR)CEO}$	100 150	V
Collector-Base Cutoff Current $V_{CB} = 50\text{ V}$	2N3498L, 2N3499L	I_{CBO}		50 nA
$V_{CB} = 75\text{ V}$	2N3500L, 2N3501L		50 nA	
$V_{CB} = 100\text{ V}$	2N3498L, 2N3499L		10 μA	
$V_{CB} = 150\text{ V}$	2N3500L, 2N3501L		10 μA	
Emitter-Base Cutoff Current $V_{EB} = 4.0\text{ V}$		I_{EBO}		25 nA
$V_{EB} = 6.0\text{ V}$			10 μA	

ON CHARACTERISTICS ⁽¹⁾

Forward-Current Transfer Ratio $I_C = 0.1\text{ mA}$, $V_{CE} = 10\text{ V}$	2N3498L, 2N3500L 2N3499L, 2N3501L	h_{FE}	20 35		
$I_C = 1.0\text{ mA}$, $V_{CE} = 10\text{ V}$	2N3498L, 2N3500L 2N3499L, 2N3501L		25 50		
$I_C = 10\text{ mA}$, $V_{CE} = 10\text{ V}$	2N3498L, 2N3500L 2N3499L, 2N3501L		35 75		
$I_C = 150\text{ mA}$, $V_{CE} = 10\text{ V}$	2N3498L, 2N3500L 2N3499L, 2N3501L		40 100	120 300	
$I_C = 300\text{ mA}$, $V_{CE} = 10\text{ V}$	2N3500L 2N3501L		15 20		
$I_C = 500\text{ mA}$, $V_{CE} = 10\text{ V}$	2N3498L 2N3499L		15 20		
Collector-Emitter Saturation Voltage $I_C = 10\text{ mA}$, $I_B = 1.0\text{ mA}$	All Types		$V_{CE(sat)}$		0.2 V
$I_C = 300\text{ mA}$, $I_B = 30\text{ mA}$	2N3498L, 2N3499L			0.6 V	
$I_C = 150\text{ mA}$, $I_B = 15\text{ mA}$	2N3500L, 2N3501L	0.4 V			
Base-Emitter Saturation Voltage $I_C = 10\text{ mA}$, $I_B = 1.0\text{ mA}$	All Types	$V_{BE(sat)}$		0.8 V	
$I_C = 300\text{ mA}$, $I_B = 30\text{ mA}$	2N3498L, 2N3499L		1.4 V		
$I_C = 150\text{ mA}$, $I_B = 15\text{ mA}$	2N3500L, 2N3501L		1.2 V		

DYNAMIC CHARACTERISTICS

Forward Current Transfer Ratio, Magnitude $I_C = 20\text{ mA}$, $V_{CE} = 20\text{ V}$, $f = 100\text{ MHz}$		$ h_{fe} $	1.5	8.0	
Output Capacitance $V_{CB} = 10\text{ V}$, $I_E = 0$, $100\text{ kHz} \leq f \leq 1.0\text{ MHz}$	2N3498L, 2N3499L 2N3500L, 2N3501L	C_{obo}		10 8.0	μF
Input Capacitance $V_{EB} = 0.5\text{ V}$, $I_C = 0$, $100\text{ kHz} \leq f \leq 1.0\text{ MHz}$			C_{ibo}		80

(1) Pulse Test: pulse width = 300 μs , duty cycle $\leq 2.0\%$.

ELECTRICAL CHARACTERISTICS @ $T_A = +25\text{ }^\circ\text{C}$, unless otherwise noted (continued)
SWITCHING CHARACTERISTICS

Parameters / Test Conditions	Symbol	Min.	Max.	Unit
Turn-On Time $V_{EB} = 5\text{ V}; I_C = 150\text{ mA}; I_{B1} = 15\text{ mA}$	t_{on}		115	ns
Turn-Off Time $I_C = 150\text{ mA}; I_{B1} = I_{B2} = -15\text{ mA}$	t_{off}		1150	ns

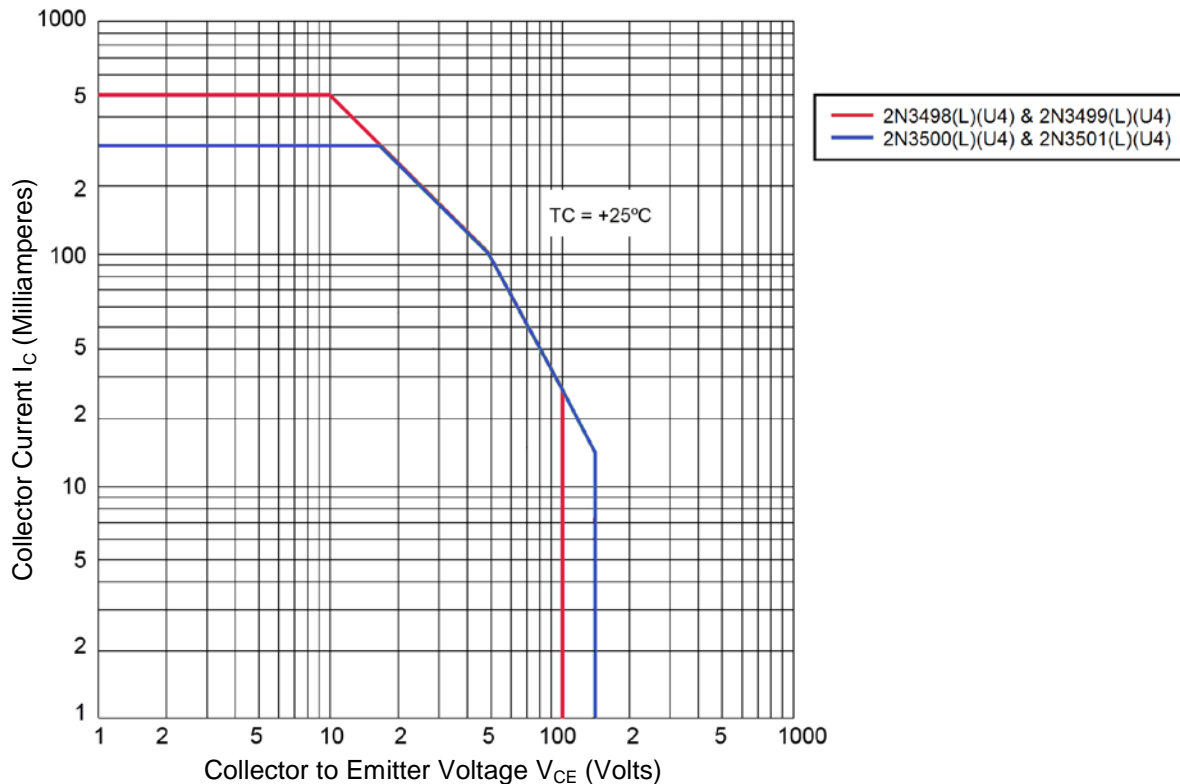
SAFE OPERATING AREA (See SOA figure and reference [MIL-STD-750 method 3053](#))
DC Tests
 $T_C = +25\text{ }^\circ\text{C}, t_r \geq 10\text{ ns}; 1\text{ Cycle}, t = 1.0\text{ s}$
Test 1
 $V_{CE} = 10\text{ V}, I_C = 500\text{ mA}$ 2N3498L, 2N3499L

 $V_{CE} = 16.67\text{ V}, I_C = 300\text{ mA}$ 2N3500L, 2N3501L

Test 2
 $V_{CE} = 50\text{ V}, I_C = 100\text{ mA}$ All Types

Test 3
 $V_{CE} = 80\text{ V}, I_C = 40\text{ mA}$ All Types

Clamped Switching
 $T_A = +25\text{ }^\circ\text{C}$
Test 1
 $I_B = 85\text{ mA}, I_C = 500\text{ mA}$ 2N3498L, 2N3499L

 $I_B = 50\text{ mA}, I_C = 300\text{ mA}$ 2N3500L, 2N3501L


Maximum Safe Operating Area

ELECTRICAL CHARACTERISTICS @ $T_A = +25\text{ }^\circ\text{C}$, unless otherwise noted (continued)
POST RADIATION ELECTRICAL CHARACTERISTICS

Parameters / Test Conditions	Symbol	Min.	Max.	Unit
Collector-Emitter Breakdown Voltage $I_C = 10\text{ mA}$ 2N3498L, 2N3499L 2N3500L, 2N3501L	$V_{(BR)CEO}$	100 150		V
Collector-Base Cutoff Current $V_{CB} = 100\text{ V}$ $V_{CB} = 150\text{ V}$ $V_{CB} = 50\text{ V}$ $V_{CB} = 75\text{ V}$ 2N3498L, 2N3499L 2N3500L, 2N3501L 2N3498L, 2N3499L 2N3500L, 2N3501L	I_{CBO}		20 20 100 100	μA μA nA nA
Collector to Emitter Cutoff $V_{CE} = 80\text{ V}$ $V_{CE} = 120\text{ V}$ 2N3498L, 2N3499L 2N3500L, 2N3501L	I_{CEO}		2	μA
Emitter-Base Cutoff Current $V_{EB} = 4.0\text{ V}$ $V_{EB} = 6.0\text{ V}$	I_{EBO}		50 20	nA μA
Forward-Current Transfer Ratio $I_C = 0.1\text{ mA}$, $V_{CE} = 10\text{ V}$ 2N3498L, 2N3500L 2N3499L, 2N3501L $I_C = 1.0\text{ mA}$, $V_{CE} = 10\text{ V}$ 2N3498L, 2N3500L 2N3499L, 2N3501L $I_C = 10\text{ mA}$, $V_{CE} = 10\text{ V}$ 2N3498L, 2N3500L 2N3499L, 2N3501L $I_C = 150\text{ mA}$, $V_{CE} = 10\text{ V}$ 2N3498L, 2N3500L 2N3499L, 2N3501L $I_C = 300\text{ mA}$, $V_{CE} = 10\text{ V}$ 2N3500L 2N3501L $I_C = 500\text{ mA}$, $V_{CE} = 10\text{ V}$ 2N3498L 2N3499L	$[h_{FE}]$	[10] [17.5] [12.5] [25] [17.5] [37.5] [20] [50] [7.5] [10] [7.5] [10]	120 300	
Collector-Emitter Saturation Voltage $I_C = 10\text{ mA}$, $I_B = 1.0\text{ mA}$ $I_C = 300\text{ mA}$, $I_B = 30\text{ mA}$ $I_C = 150\text{ mA}$, $I_B = 15\text{ mA}$ All Types 2N3498L, 2N3499L 2N3500L, 2N3501L	$V_{CE(sat)}$		0.23 0.69 0.46	V
Base-Emitter Saturation Voltage $I_B = 10\text{ mA}$, $I_C = 1.0\text{ mA}$ $I_B = 300\text{ mA}$, $I_C = 30\text{ mA}$ $I_B = 150\text{ mA}$, $I_C = 15\text{ mA}$ All Types 2N3498L, 2N3499L 2N3500L, 2N3501L	$V_{BE(sat)}$		0.92 1.61 1.38	V

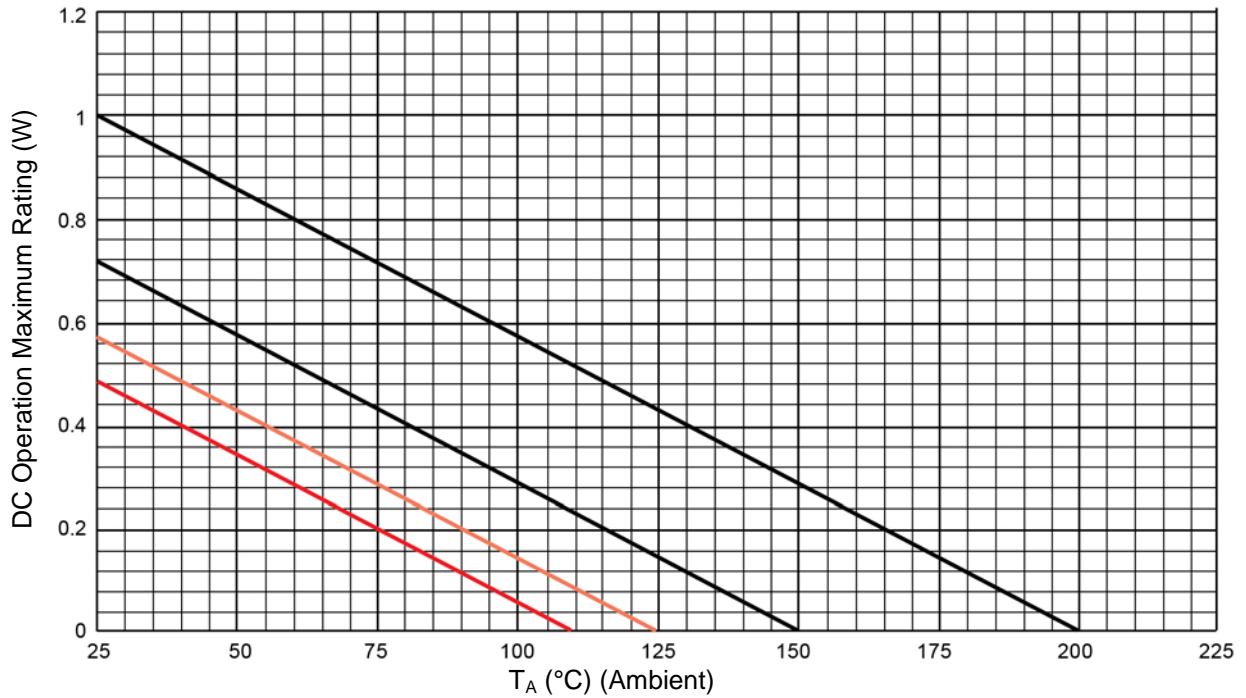
GRAPHS


FIGURE 1
Derating for all devices ($R_{\theta JA}$)

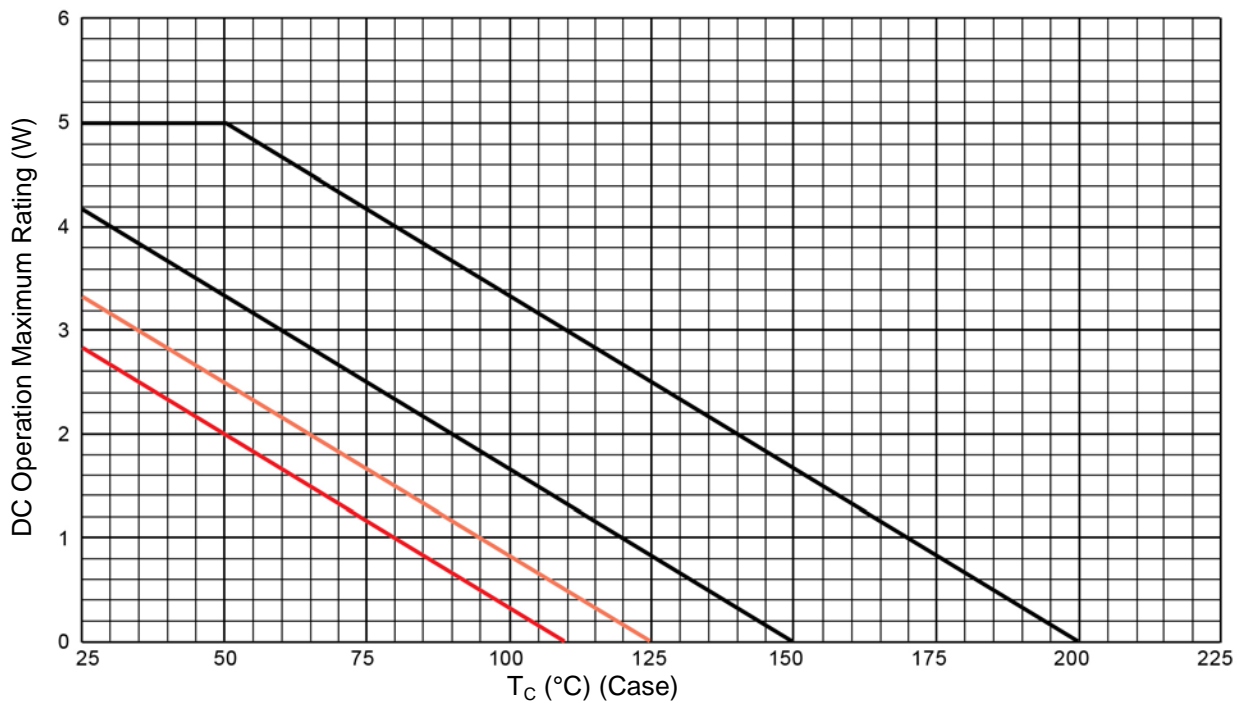


FIGURE 2
Derating for all devices ($R_{\theta JC}$)

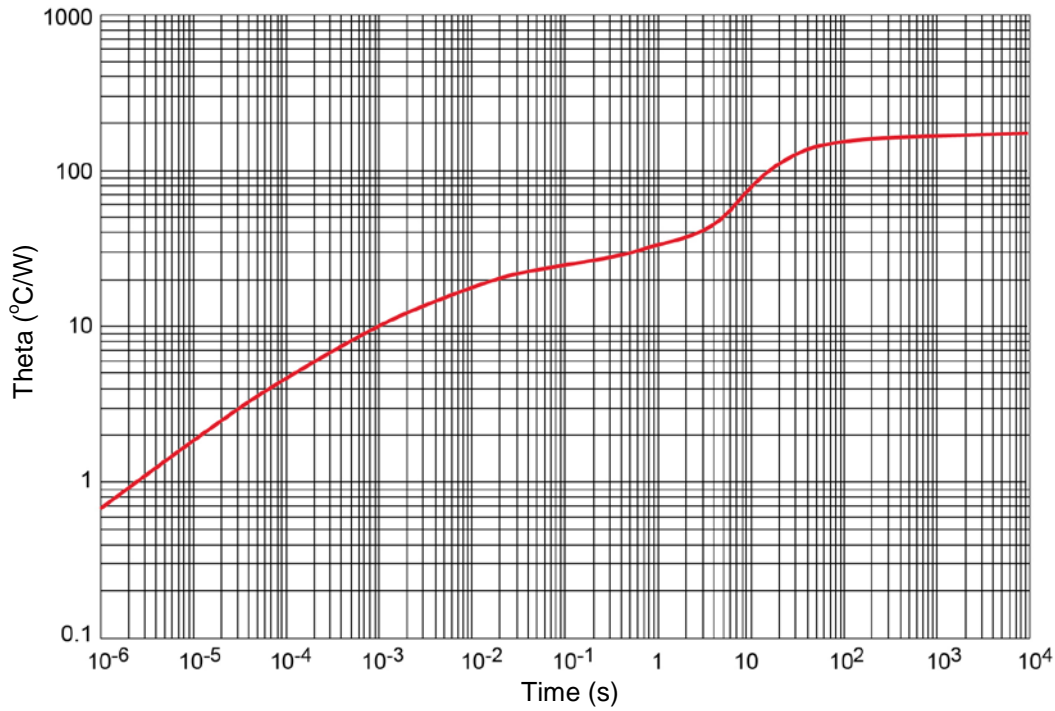
GRAPHS (continued)


FIGURE 3
Thermal Impedance Graph ($R_{\theta JA}$)

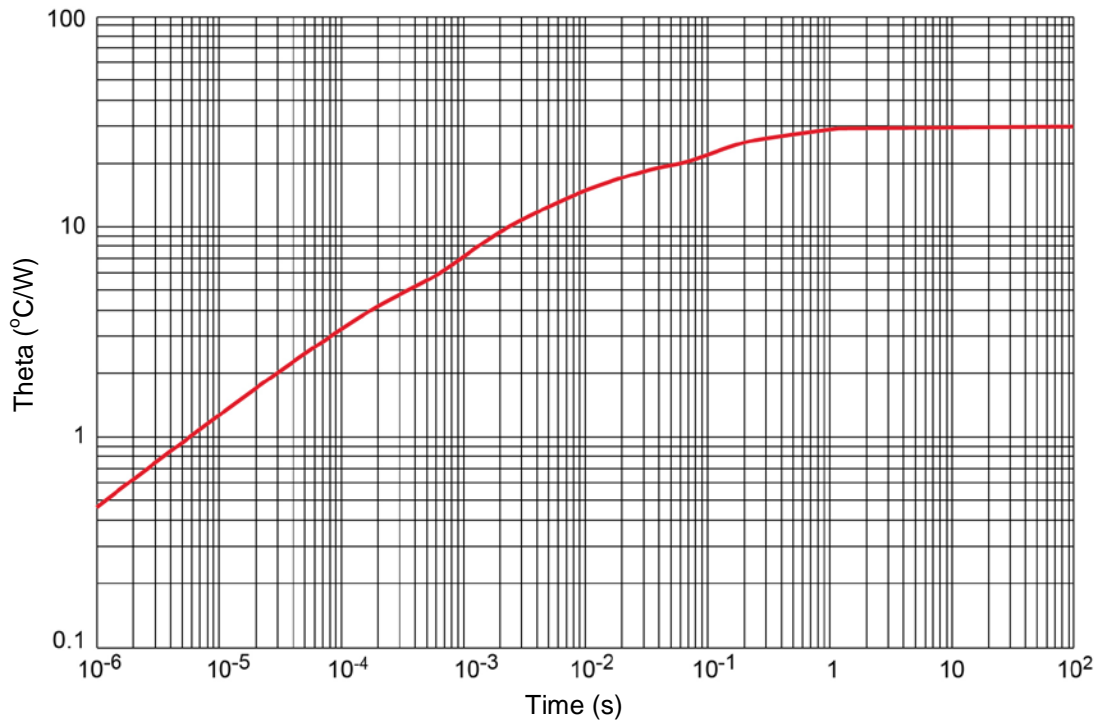
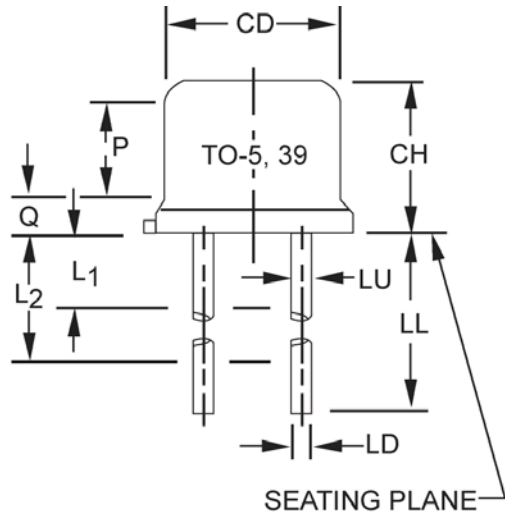
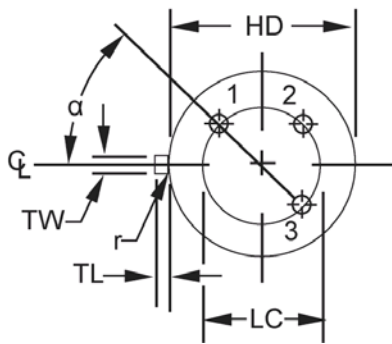


FIGURE 4
Thermal Impedance Graph ($R_{\theta JC}$)

PACKAGE DIMENSIONS


Symbol	Dimensions				Note
	Inches		Millimeters		
	Min	Max	Min	Max	
CD	0.305	0.335	7.75	8.51	
CH	0.240	0.260	6.10	6.60	
HD	0.335	0.370	8.51	9.40	
LC	0.200 TP		5.08 TP		6
LD	0.016	0.021	0.41	0.53	7
LL	1.500	1.750	38.10	44.50	7, 12
LU	0.016	0.019	0.41	0.48	7, 12
L1		0.050		1.27	12
L2	0.250		6.35		12
P	0.100		2.54		5
Q		0.050		1.27	4
TL	0.029	0.045	0.74	1.14	3
TW	0.028	0.034	0.71	0.86	10, 11
r		0.010		0.25	11
α	45° TP		45° TP		6


NOTES:

1. Dimension are in inches.
2. Millimeters are given for general information only.
3. Symbol TL is measured from HD maximum.
4. Details of outline in this zone are optional.
5. Symbol CD shall not vary more than .010 (0.25 mm) in zone P. This zone is controlled for automatic handling.
6. Leads at gauge plane .054 inch (1.37 mm) +.001 inch (0.03 mm) -.000 inch (0.00 mm) below seating plane shall be within .007 inch (0.18 mm) radius of true position (TP) relative to tab. Device may be measured by direct methods or by gauge.
7. Symbol LD applies between L1 and L2. Dimension LD applies between L2 and LL minimum. Lead diameter shall not exceed .042 inch (1.07 mm) within L1 and beyond LL minimum.
8. Lead designation, shall be as follows: 1 - emitter, 2 - base, 3 - collector.
9. Lead number three is electrically connected to case.
10. Beyond r maximum, TW shall be held for a minimum length of .011 inch (0.28 mm).
11. Symbol r applied to both inside corners of tab.
12. All three leads.
13. In accordance with ASME Y14.5M, diameters are equivalent to Φ x symbology.